

Application Information

The TCPS260 is a PICMG CPCI-S.0 R2.0 compatible 3U module that provides one slot for a single-width PMC module used to build modular, flexible and cost effective I/O solutions for all kinds of applications like process control, medical systems, telecommunication and traffic control.

The TCPS260 is a versatile solution to upgrade well known PMC I/O solutions to the CompactPCI Serial standard.

The bridging between the system host board and the PMC slot is handled by a transparent PCIe-to-PCI Bridge. The Bridge provides an x1, Rev. 2.0 PCIe link with 2.5 Gbps signaling rate.

On the PMC side, PCI signaling voltages of 3.3V and 5V are supported; 3.3V signaling is default. 32-bit PCI accesses are possible with 33MHz or 66MHz. The TCPS260 supports PMC front-panel I/O.

Technical Information

- Form Factor: 3U CPCI-S.0 R2.0
 D Board size: 160 mm x 100 mm
- One PMC site conforming to IEEE 1386.1
 - O PCI Interface: 33/66 MHz, 32-Bit
 - PCI I/O Signaling Voltage: 3.3V or 5V (3.3V factory default)
 - PMC Front Panel I/O

XIO2001 PCIe-to-PCI Bridge
 PCI Express x1, Revision 2.0

- O 2.5 Gbps signaling rate
- O Operating temperature -40°C to +85°C
- MTBF (MIL-HDBK217F/FN2 GB 20°C) TCPS260-10R: 672000 h

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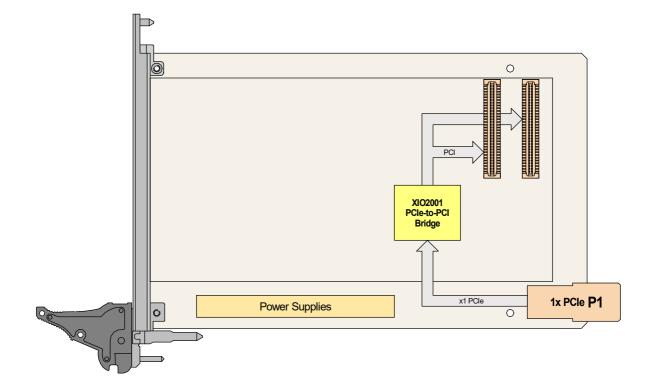


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Order Information	
RoHS Compliant TCPS260-10R	3U CompactPCI Serial PMC Module Carrier, PCIe x1
Documentation TCPS260-DOC	User Manual

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